

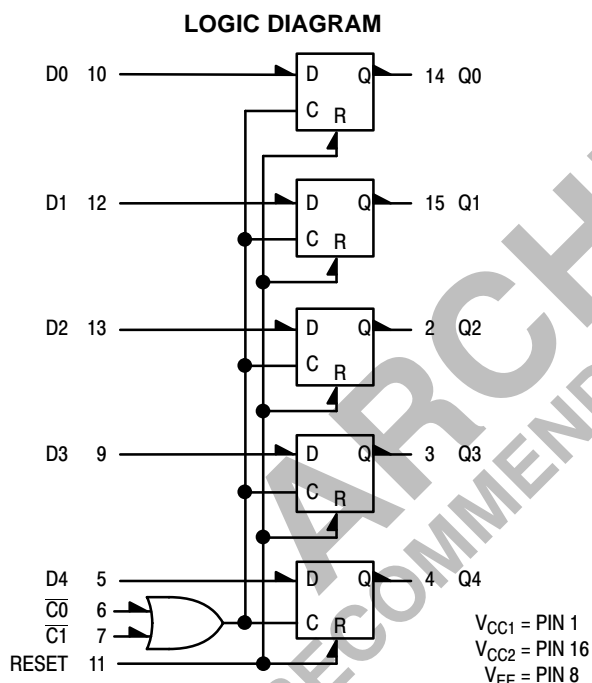
# MC10175

## Quint Latch

The MC10175 is a high speed, low power quint latch. It features five D type latches with common reset and a common two-input clock. Data is transferred on the negative edge of the clock and latched on the positive edge. The two clock inputs are "OR"ed together.

Any change on the data input will be reflected at the outputs while the clock is low. The outputs are latched on the positive transition of the clock. While the clock is in the high state, a change in the information present at the data inputs will not affect the output information. The reset input is enabled only when the clock is in the high state.

- $P_D = 400 \text{ mW typ/pkg (No Load)}$
- $t_{pd} = 2.5 \text{ ns typ (Data to Output)}$
- $t_r, t_f = 2.0 \text{ ns typ (20\%–80\%)}$



**TRUTH TABLE**

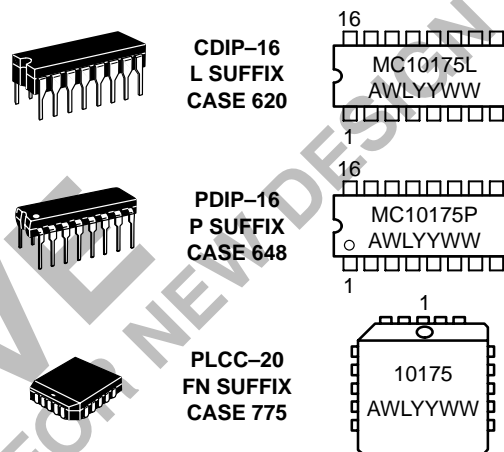
D	$\overline{C0}$	$\overline{C1}$	Reset	$Q_{n+1}$
L	L	L	X	L
H	L	L	X	H
X	H	X	L	$Q_n$
X	X	H	L	$Q_n$
X	H	X	H	L
X	X	H	H	L



**ON Semiconductor**

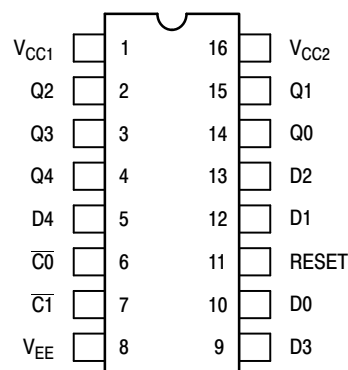
<http://onsemi.com>

### MARKING DIAGRAMS



A = Assembly Location  
 WL = Wafer Lot  
 YY = Year  
 WW = Work Week

### DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.  
 For PLCC pin assignment, see the Pin Conversion Tables on page 18 of the ON Semiconductor MECL Data Book (DL122/D).

### ORDERING INFORMATION

Device	Package	Shipping
MC10175L	CDIP-16	25 Units / Rail
MC10175P	PDIP-16	25 Units / Rail
MC10175FN	PLCC-20	46 Units / Rail

## ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit
			−30°C		+25°C			+85°C		
			Min	Max	Min	Typ	Max	Min	Max	
Power Supply Drain Current	I <sub>E</sub>	8		107		78	97		107	mAdc
Input Current	I <sub>inH</sub>	6		460			290		290	μAdc
		7		460			290		290	
		10		460			290		290	
		11		1000			650		650	
	I <sub>inL</sub>	All	0.5		0.5			0.3		μAdc
Output Voltage      Logic 1	V <sub>OH</sub>	14	−1.060	−0.890	−0.960		−0.810	−0.890	−0.700	Vdc
		15	−1.060	−0.890	−0.960		−0.810	−0.890	−0.700	
Output Voltage      Logic 0	V <sub>OL</sub>	14	−1.890	−1.675	−1.850		−1.650	−1.825	−1.615	Vdc
		15	−1.890	−1.675	−1.850		−1.650	−1.825	−1.615	
Threshold Voltage    Logic 1	V <sub>OHA</sub>	14	−1.080		−0.980			−0.910		Vdc
		15	−1.080		−0.980			−0.910		
Threshold Voltage    Logic 0	V <sub>OLA</sub>	14		−1.655			−1.630		−1.595	Vdc
		15		−1.655			−1.630		−1.595	
Switching Times (50Ω Load)										ns
Data Input	t <sub>10+14+</sub> t <sub>10−14−</sub>	14	1.0	3.6	1.0		3.5	1.0	3.6	
		14	1.0	3.6	1.0		3.5	1.0	3.6	
Clock Input	t <sub>6−14+</sub> t <sub>6−14−</sub>	14	1.0	4.7	1.0		4.3	1.0	4.4	
		14	1.0	4.7	1.0		4.3	1.0	4.4	
Reset Input	t <sub>11+4−</sub> t <sub>11+14−</sub>	4	1.0	4.0	1.0		3.9	1.0	4.2	
		14	1.0	4.0	1.0		3.9	1.0	4.2	
Setup Time	t <sub>setup</sub>	14	2.5		2.5			2.5		
Hold Time	t <sub>hold</sub>	14	1.5		1.5			1.5		
Rise Time            (20 to 80%)	t <sub>+</sub>	14	1.0	3.6	1.1		3.5	1.1	3.7	
Fall Time            (20 to 80%)	t <sub>−</sub>	14	1.0	3.6	1.1		3.5	1.1	3.7	

1. Individually test each input; apply  $V_{ILmin}$  to pin under test.
2. Output latched to high logic state prior to test.

## ELECTRICAL CHARACTERISTICS (continued)

@ Test Temperature			TEST VOLTAGE VALUES (Volts)					(V <sub>CC</sub> ) Gnd
			V <sub>IHmax</sub>	V <sub>ILmin</sub>	V <sub>IHAmin</sub>	V <sub>ILAmx</sub>	V <sub>EE</sub>	
			−30°C	−0.890	−1.890	−1.205	−1.500	−5.2
			+25°C	−0.810	−1.850	−1.105	−1.475	−5.2
			+85°C	−0.700	−1.825	−1.035	−1.440	−5.2
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW					(V <sub>CC</sub> ) Gnd
			V <sub>IHmax</sub>	V <sub>ILmin</sub>	V <sub>IHAmin</sub>	V <sub>ILAmx</sub>	V <sub>EE</sub>	
Power Supply Drain Current	I <sub>E</sub>	8					8	1, 16
Input Current	I <sub>inH</sub>	6	6				8	1, 16
		7	7				8	1, 16
		10	10				8	1, 16
		11	11				8	1, 16
	I <sub>inL</sub>	All		Note 1.			8	1, 16
Output Voltage	Logic 1	V <sub>OH</sub>	14	10	6		8	1, 16
			15	12	6		8	1, 16
Output Voltage	Logic 0	V <sub>OL</sub>	14	6, 10			8	1, 16
			15	6, 12			8	1, 16
Threshold Voltage	Logic 1	V <sub>OHA</sub>	14	6	10		8	1, 16
			15	6	12		8	1, 16
Threshold Voltage	Logic 0	V <sub>OLA</sub>	14	6		10	8	1, 16
			15	6		12	8	1, 16
Switching Times (50Ω Load)			+1.11V	+0.31V	Pulse In	Pulse Out	−3.2 V	+2.0 V
Data Input	t <sub>10+14+</sub> t <sub>10−14−</sub>	14		6, 7	10	14	8	1, 16
		14		6, 7	10	14	8	1, 16
Clock Input	t <sub>6−14+</sub> t <sub>6−14−</sub>	14		7	10, 6	14	8	1, 16
		14		7	10, 6	14	8	1, 16
Reset Input	t <sub>11+4−</sub> t <sub>11+14−</sub>	4	5	6	7, 11	4 (2.)	8	1, 16
		14	10	6	7, 11	14 (2.)	8	1, 16
Setup Time	t <sub>setup</sub>	14		7	6, 10	14	8	1, 16
Hold Time	t <sub>hold</sub>	14		7	6, 10	14	8	1, 16
Rise Time (20 to 80%)	t <sub>+</sub>	14		6, 7	10	14	8	1, 16
Fall Time (20 to 80%)	t <sub>−</sub>	14		6, 7	10	14	8	1, 16

1. Individually test each input; apply V<sub>ILmin</sub> to pin under test.
2. Output latched to high logic state prior to test.

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to −2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

# MC10175

## PACKAGE DIMENSIONS

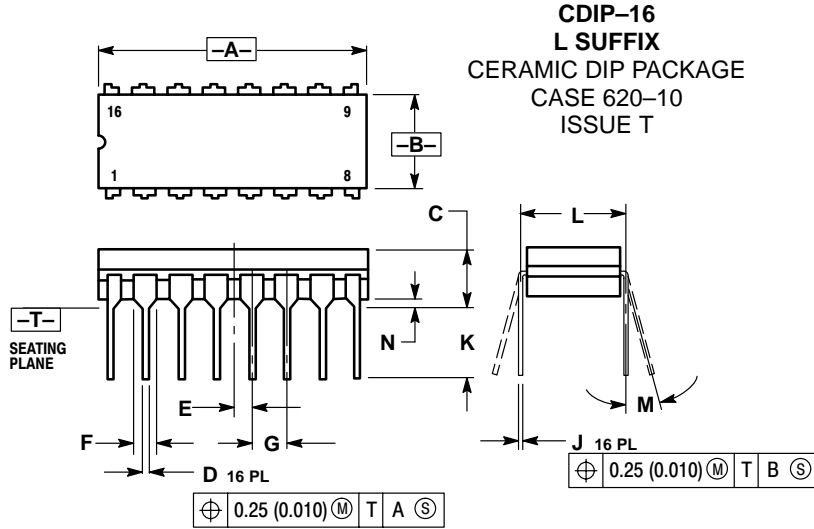
PLCC-20  
FN SUFFIX  
PLASTIC PLCC PACKAGE  
CASE 775-02  
ISSUE C



DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.385	0.395	9.78	10.03
B	0.385	0.395	9.78	10.03
C	0.165	0.180	4.20	4.57
E	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050 BSC		1.27 BSC	
H	0.026	0.032	0.66	0.81
J	0.020	---	0.51	---
K	0.025	---	0.64	---
R	0.350	0.356	8.89	9.04
U	0.350	0.356	8.89	9.04
V	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
X	0.042	0.056	1.07	1.42
Y	---	0.020	---	0.50
Z	2 °	10 °	2 °	10 °
G1	0.310	0.330	7.88	8.38
K1	0.040	---	1.02	---

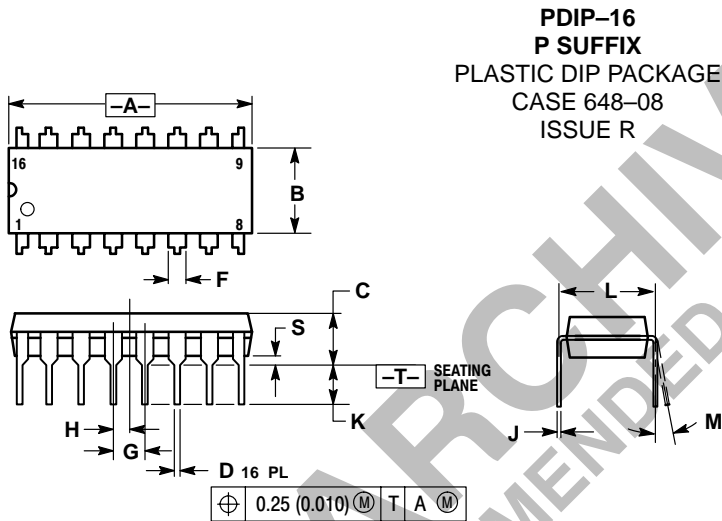
# MC10175

## PACKAGE DIMENSIONS



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
  4. DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.750	0.785	19.05	19.93
B	0.240	0.295	6.10	7.49
C	---	0.200	---	5.08
D	0.015	0.020	0.39	0.50
E	0.050 BSC		1.27 BSC	
F	0.055	0.065	1.40	1.65
G	0.100 BSC		2.54 BSC	
H	0.008	0.015	0.21	0.38
K	0.125	0.170	3.18	4.31
L	0.300 BSC		7.62 BSC	
M	0°	15°	0°	15°
N	0.020	0.040	0.51	1.01



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
  4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
  5. ROUNDED CORNERS OPTIONAL.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.740	0.770	18.80	19.55
B	0.250	0.270	6.35	6.85
C	0.145	0.175	3.69	4.44
D	0.015	0.021	0.39	0.53
F	0.040	0.70	1.02	1.77
G	0.100 BSC		2.54 BSC	
H	0.050 BSC		1.27 BSC	
J	0.008	0.015	0.21	0.38
K	0.110	0.130	2.80	3.30
L	0.295	0.305	7.50	7.74
M	0°	10°	0°	10°
S	0.020	0.040	0.51	1.01

**Notes**

**ARCHIVE**  
DEVICE NOT RECOMMENDED FOR NEW DESIGN

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